Brief Description

The ZSC31150 is a CMOS integrated circuit for highly accurate amplification and sensor-specific correction of bridge sensor signals. Digital compensation of sensor offset, sensitivity, temperature drift, and non-linearity is accomplished via an internal 16-bit RISC microcontroller running a correction algorithm, with calibration coefficients stored in an EEPROM.

The ZSC31150 is adjustable to nearly all bridge sensor types. Measured values are provided at the analog voltage output or at the digital ZACwire™ and I ²C interface. The digital interface can be used for a simple PC-controlled calibration procedure in order to program a set of calibration coefficients into an on-chip EEPROM. A specific sensor and a ZSC31150 can be mated digitally: fast, precise, and without the cost overhead associated with trimming by external devices or a laser.

Features

- Digital compensation of sensor offset, sensitivity, temperature drift, and non-linearity
- Adjustable to nearly all bridge sensor types
- Analog gain of up to 420
- Output options: ratiometric analog voltage output (5% to 95% maximum, 12.4-bit resolution) or ZACwire™ (digital one-wireinterface)
- Temperature compensation: internal or external diode, bridge resistance, thermistor
- Sensor biasing by voltage or constant current
- Sample rate: up to 7.8kHz
- High voltage protection up to 33V
- Supply current: max. 5.5mA
- Reverse polarity and short-circuit protection
- Wide operation temperature depending on part number: up to -40°C to +150°C
- Traceability by user-defined EEPROM entries
- Safety and diagnostic functions

Benefits

- No external trimming components required
- Only a few external protection devices needed
- PC-controlled configuration and single pass calibration via I ²C or ZACwire™ interface: simple, cost efficient, quick, and precise
- End-of-line calibration via I2C or ZACwire™ interface
- High accuracy (0.25% FSO at -25 to 85°C; 0.5% FSO at -40°C to 125°C)
- Excellent EMC/ESD robustness and AEC-Q100 qualification

Available Support

- Evaluation Kits
- Application Notes
- Mass Calibration System

Physical Characteristics

- Supply voltage: 4.5V to 5.5V
- Operation temperature: -40°C to 125°C (-40°C to +150°C extended temperature range)
- Available as 14-DFN (5×4 mm; wettable flanks), SSOP14, and die

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1. Electrical Characteristics

1.1 Absolute Maximum Ratings

The absolute maximum ratings are stress ratings only. The ZSC31150 might not function or be operable above the recommended operating conditions. Stresses exceeding the absolute maximum ratings might also damage the device. In addition, extended exposure to stresses above the recommended operating conditions might affect device reliability. IDT does not recommend designing to the "Absolute Maximum Ratings."

Parameters apply in operation temperature range and without time limitations.

Table 1.1 Absolute Maximum Ratings

No.	Parameter	Symbol	Conditions	Min	Max	Unit
1.1.1	Supply voltage [a]	VDDE	To VSSE.	-33	33	VDC
1.1.2	Potential at the AOUT pin [a]	VOUT	Relative to VSSE.	-33	33	VDC
1.1.3	Analog supply voltage [a]	VDDA	Relative to VSSA. $VDDE - VDDA < 0.35V$	-0.3	6.5	VDC
1.1.4	Voltage at all analog and digital IO pins	V_{A_10} V _{D IO}	Relative to VSSA.	-0.3	$VDDA + 0.3$	VDC
1.1.5	Storage temperature	$\mathsf{T}_{\textsf{STG}}$		-55	150	\circ C

[a] Refer to the *ZSC31150 Technical Note – High Voltage Protection* for specification and detailed conditions for high voltage protection.

1.2 Operating Conditions

All voltages are related to VSSA. See important table notes at the end of the table.

Table 1.2 Operating Conditions

[a] Refer to the temperature profile description in the *ZSC31150 Technical Note – Die and Package Specifications* for operation in temperature range $> 125^{\circ}$ C.

[b] No measurement in mass production; parameter is guaranteed by design and/or quality observation.

- [c] Symmetric behavior and identical electrical properties (especially with regard to the low pass characteristic) of both sensor inputs of the ZSC31150 are required. Unsymmetrical conditions of the sensor and/or external components connected to the sensor input pins of ZSC31150 can generate a failure in signal operation.
- [d] See application circuit components i[n Table 3.1.](#page-17-2)

1.3 Electrical Parameters

All parameter values are valid for operating conditions specified in section [1.2](#page-4-2) except as noted. All voltages related to VSSA. See important table notes at the end of the table.

Table 1.3 Electrical Parameters

[a] No measurement in mass production; parameter is guaranteed by design and/or quality observation.

[b] Refer to sectio[n 2.4.](#page-14-0)

[c] Minimum output voltage to VDDE or maximum output voltage to VSSE.

[d] Depends on resolution and configuration - start routine begins approximately 0.8ms after power on.

[e] XZC is active: additional overall failure of 25ppm/K for XZC=31 at maximum; failure decreases linearly for XZC adjustments lower than 31.

1.4 Interface Characteristics and EEPROM

Table 1.4 Interface and EEPROM Characteristics

[a] Refer to the ZSC31150 Functional Description for timing details.

[b] No measurement in mass production; parameter is guaranteed by design and/or quality observation.

[c] Note that the package and temperature versions cause additional restrictions.

[d] Over lifetime; use calculation sheet *SSC Temperature Profile Calculation Spreadsheet* for temperature stress calculation; note additional restrictions are caused by different package and temperature versions.

2. Circuit Description

Note: This data sheet provides specifications and a general overview of ZSC31150 operation. For details of operation, including configuration settings and related EEPROM registers, refer to the *ZSC31150 Functional Description*.

2.1 Signal Flow

The ZSC31150's signal path includes both analog (shown in blue in [Figure 2.1\)](#page-9-3) and digital (pink) sections. The analog path is differential; i.e., the differential bridge sensor signal is handled internally via two signal lines that are symmetrical around a common mode potential (analog ground = VDDA/2), which improves noise rejection.

Consequently, it is possible to amplify positive and negative input signals, which are located within the common mode range of the signal input.

Figure 2.1 Block Diagram of the ZSC31150

The differential signal from the bridge sensor is pre-amplified by the programmable gain amplifier (PGA). The multiplexer (MUX) transmits the signals from either the bridge sensor, the external diode, or the separate temperature sensor to the analog-to-digital converter (ADC) in a specific sequence (the internal pn-junction (TS) can be used instead of the external temperature diode). Next, the ADC converts these signals into digital values.

The digital signal correction takes place in the calibration microcontroller (CMC). It is based on a correction formula located in the ROM and sensor-specific coefficients stored in the EEPROM during calibration. Depending on the programmed output configuration, the corrected sensor signal is output as an analog value or in a digital format (I²C or ZACwire™). The configuration data and the correction parameters can be programmed into the EEPROM via the digital interfaces.

2.2 Application Modes

For each application, a configuration set must be established (generally prior to calibration) by programming the on-chip EEPROM regarding to the following modes:

Sensor Channel

- Sensor mode: ratiometric bridge excitation in voltage or current supply mode.
- Input range: the gain adjustment of the AFE with respect to the maximum sensor signal span and the zero point of the ADC have to be chosen.
- An additional analog offset compensation, the Extended Zero-Point Compensation (XZC), must be enabled if required; e.g., if the sensor offset voltage is close to or larger than the sensor span.
- Resolution/response time: The ADC must be configured for resolution and conversion settings (1st or 2nd order). These settings influence the sampling rate, signal integration time, and, as a result, the noise immunity.

Temperature

Temperature measurement: the source for the temperature correction must be chosen.

2.3 Analog Front End (AFE)

The analog front end (AFE) consists of the programmable gain amplifier (PGA), the multiplexer (MUX), and the analog-to-digital converter (ADC).

2.3.1 Programmable Gain Amplifier (PGA)

[Table 2.1](#page-10-3) shows the adjustable gains, the sensor signal spans, and the allowed common mode range.

	Overall Gain	Max. Span V_{IN_SP}	Gain	Gain	Gain	Input Common Mode Range V _{IN CM} as % of VDDA [b]	
No.	a _{IN}	$[MV/V]$ [a]	Amp1	Amp ₂	Amp3	$XZC = Off$	$XZC = On$
	420	1.8	30	7	$\overline{2}$	29 to 65	45 to 55
$\overline{2}$	280	2.7	30	4.66	$\overline{2}$	29 to 65	45 to 55
3	210	3.6	15	$\overline{7}$	$\overline{2}$	29 to 65	45 to 55
4	140	5.4	15	4.66	$\overline{2}$	29 to 65	45 to 55
5	105	7.1	7.5	$\overline{7}$	$\overline{2}$	29 to 65	45 to 55
6	70	10.7	7.5	4.66	$\overline{2}$	29 to 65	45 to 55
7	52.5	14.3	3.75	7	$\overline{2}$	29 to 65	45 to 55
8	35	21.4	3.75	4.66	$\overline{2}$	29 to 65	45 to 55
9	26.3	28.5	3.75	3.5	$\overline{2}$	29 to 65	45 to 55
10	14	53.75	1	$\overline{7}$	$\overline{2}$	29 to 65	45 to 55
11	9.3	80	1	4.66	$\overline{2}$	29 to 65	45 to 55
12	$\overline{7}$	107	1	3.5	$\overline{2}$	29 to 65	45 to 55
13	2.8	267		1.4	$\overline{2}$	32 to 57	not applicable

Table 2.1 Adjustable Gains, Resulting Sensor Signal Spans, and Common Mode Ranges

[a] Recommended internal signal range maximum is 80% of the VDDA voltage. Span is calculated by the following formula: Span = 80% / gain.

[b] Bridge in Voltage Mode with maximum input signal (with XZC = +300% Offset), 14-bit accuracy. Refer to the *ZSC31150 Functional Description* for usable input signal/common mode range at bridge in current mode. See section [2.3.2](#page-10-2) for an explanation of the extended analog zero compensation (XZC).

2.3.2 Offset Compensation

The ZSC31150 supports two methods of sensor offset compensation (zero shift):

- Digital offset correction
- XZC: analog compensation for large offset values (up to a maximum of approximately 300% of the span, depending on the gain adjustment)

The digital sensor offset correction will be processed during the digital signal correction/conditioning by the calibration microcontroller (CMC).

Analog sensor offset pre-compensation is needed for compensation of large offset values, which would overdrive the analog signal path by uncompensated gaining. For analog sensor offset pre-compensation, a compensation voltage is added in the analog pre-gaining signal path (coarse offset removal). The analog offset compensation in the AFE can be adjusted by 6 EEPROM bits (refer to the *ZSC31150 Functional Description* for details).

Table 2.2 Analog Zero Point Shift Ranges (XZC)

2.3.3 Measurement Cycle

The complete measurement cycle is controlled by the CMC. Depending on EEPROM settings, the multiplexer (MUX) selects the following input signals in a defined sequence:

- Temperature measured by external diode or thermistor, internal pn-junction, or bridge
- Internal offset of the input channel (V_{OFF})
- Pre-amplified bridge sensor signal

The cycle diagram in [Figure 2.2](#page-12-1) shows the basic structure of the measurement cycle. The bridge sensor measurement count can be configured in EEPROM for a value within n=<1,31>.

After power-on, the startup routine is processed, which performs all measurements needed to acquire an initial valid conditioned sensor output. After the startup routine, the normal measurement cycle runs.

Note: The "CMV," "SSC/SCC+" and "SSC/SCC-" measurements are always performed in every cycle independent of the EEPROM configuration.

Figure 2.2 Measurement Cycle

2.3.4 Analog-to-Digital Converter

The ADC is an integrating analog-to-digital converter in full differential switched capacitor technique.

Programmable ADC resolutions are $r_{ADC} = 13$, 14> or with segmentation, $r_{ADC} = 15$, 16> bit.

The ADC can be used as a first or second order converter. In the **first order** mode, it is inherently monotone and insensitive to short and long-term instability of the clock frequency. The conversion cycle time depends on the desired resolution and can be roughly calculated by the following equation where r_{ADC} is the ADC resolution and t_{ADC} is the conversion cycle time in seconds in first-order mode:

$$
\mathbf{t}_{\text{ADC}_1} = \frac{2^{r_{\text{ADC}}}}{\left(\frac{f_{\text{OSC}}}{2}\right)}
$$

In the **second order** mode, two conversions are stacked with the advantage of a much shorter conversion cycle time but the drawback of a lower noise immunity caused by the shorter signal integration period. The approximate conversion cycle time t_{ADC} in second-order mode is calculated by the following equation:

 $\overline{}$ J $\frac{f_{osc}}{2}$ \setminus ſ $=$ $^{+}$ 2 $t_{\text{ADC 2}} = \frac{2}{3}$ $(r_{ADC}+3)/2$ ADC_2 *OSC r f ADC*

The calculation formulas for t_{ADC} give an overview of conversion time for one AD conversion. Refer to the *ZSC31150 Bandwidth Calculation Spreadsheet* for detailed calculations for sampling time and bandwidth.

The result of the AD conversion is a relative counter result corresponding to the following equation (see the *ZSC31150 Functional Description* for more detailed equations):

$$
Z_{ADC} = 2^{r_{ADC}} \Bigg(\frac{V_{ADC_DIFF}}{V_{ADC_REF}} + RS_{ADC} \Bigg)
$$

ZADC Number of counts (result of the conversion) r_{ADC} Selected ADC resolution in bits

V_{ADC} DIFF Differential input voltage of the ADC

VADC REF Reference voltage of the ADC

 RS_{ADC} Digital ADC range shift $(RS_{ADC} = 1/16, 1/8, 1/4, 1/2,$ controlled by the EEPROM setting)

The sensor input signal can be shifted to the optimal input range of the ADC with the RSADC value.

[a] The ADC resolution should be one bit higher than the required output resolution if the AFE gain is adjusted so that more than 50% of the input range is used. Otherwise the ADC resolution should be more than one bit higher than the required output resolution.

[b] The sampling rate (A/D conversion time) is only a part of the whole cycle; refer to the *ZSC31150 Bandwidth Calculation Spreadsheet* for detailed information.

Note: The ADC's reference voltage ADC_{VREF} is defined by the potential between <VBR_T> and <VBR_B> (or <VDDA> to <VSSA>, if selected in EEPROM by the bit CFGAPP:BREF=1). Theoretically, the input range $ADC_{RANGE|NP}$ of the ADC is equivalent to the ADC's reference voltage.

In practice, the maximum ADC input range used should be from 10% to 90% of ADC_{RANGE_INP}, which is a necessary condition for ensuring the specified accuracy, stability, and nonlinearity parameters of the AFE. This condition is also valid for whole temperature range and all applicable sensor tolerances. The ZSC31150 does not have an internal failsafe function that verifies that the input meets this condition.

2.4 Temperature Measurement

The ZSC31150 supports four different methods for acquiring the temperature data needed for calibration of the sensor signal in the specified temperature range.

Temperature data can be acquired using one of these temperature sensors:

- an internal pn-junction temperature sensor
- an external pn-junction temperature sensor connected to sensor top potential (V_{BRTOP})
- an external resistive half bridge temperature sensor
- the temperature coefficient of the sensor bridge at bridge current excitation

Refer to the *ZSC31150 Functional Description* for a detailed explanation of temperature sensor adaptation and adjustment.

2.5 System Control and Conditioning Calculation

The system control supports the following tasks/features:

- Controlling the measurement cycle according to the EEPROM-stored configuration data
- Performing the16-bit correction calculation for each measurement signal using the EEPROM-stored calibration coefficients and ROMbased algorithms; i.e., the signal conditioning
- Managing the start-up sequence and starting signal conditioning
- Handling communication requests received by the digital interface
- Managing failsafe tasks for the functions of the ZSC31150 and indicating detected errors with diagnostic states

Refer to the *ZSC31150 Functional Description* for a detailed description.

2.5.1 Operation Modes

The internal state machine has three main states:

- The continuously running signal conditioning mode, which is called Normal Operation Mode (NOM)
- The calibration mode with access to all internal registers and states, which is called Command Mode (CM)
- The failure messaging mode, which is called Diagnostic Mode (DM)

2.5.2 Start Up Phase

The start-up phase* consists of following segments:

1. Internal supply voltage settling phase (i.e., the VDDA - VSSA potential), which is ended when the reset signal is disabled through the power-on clear block (POR). Refer to the *ZSC31150 Technical Note – High Voltage Protection* document*,* section 4 for power on/off thresholds.

Time (from beginning with VDDA-VSSA=0V): 500µs to 2000µs; AOUT is in tri-state

- 2. System start, EEPROM read out, and signature check (and ROM check if selected by setting EEPROM bit CFGAPP:CHKROM=1). **Time**: ~200µs (~9000µs with ROM-check; i.e., 28180 clocks); AOUT is LOW (DM)
- 3. Processing the start routine for signal conditioning (all measurements and conditioning calculations). **Time:** 5 x A/D conversion time; AOUT behavior depends on selected OWI mode (refer to sectio[n 2.6\)](#page-15-1):
	- **OWIANA & OWIDIS** => AOUT is LOW (DM)
	- **OWIWIN & OWIENA** => AOUT is in tri-state

l

All timings described are roughly estimated values and are affected by the internal clock frequency. Timings are estimated for fcLK=3MHz.

The analog output AOUT will be activated at the end of the start-up phase depending on the adjusted output and communication mode (refer to section [2.6\)](#page-15-1). If errors are detected, the Diagnostic Mode (DM) is activated and the diagnostic output signal is driven at the output.

After the start-up phase, the continuously running measurement and calibration cycle is started. Refer to *ZSC31150 Bandwidth Calculation Spreadsheet* for detailed information about output update rate.

2.5.3 Conditioning Calculation

The digitalized value for the bridge sensor measurement (acquired raw data) is processed with the correction formula to remove offset and temperature dependency and to compensate nonlinearity up to 3rd order. The result of the correction calculation is a non-negative 15-bit value for the bridge sensor in the range [0; 1). This value P is clipped with programmed limitation coefficients and continuously written to the output register of the digital serial interface and the output DAC.

Note: The conditioning includes up to third-order nonlinearity sensor input correction. The available adjustment ranges depend on the specific calibration parameters; for a detailed description, refer to *ZSC31150 Functional Description.* Basically, offset compensation and linear correction are only limited by the loss of resolution they will cause. The second-order correction is possible up to approximately 30% of the full scale difference from a straight line; third order is possible up to approximately 20% (ADC resolution = 13-bit). The calibration principle used is able to reduce existing nonlinearity errors of the sensor up to 90%. The temperature calibration includes first and second order correction and should be fairly sufficient in all relevant cases. ADC resolution also influences calibration possibilities; e.g., 1 additional bit of resolution reduces the calibration range by approximately 50%. The maximum calculation input data width is 14-bit. The 15 or 16 bit ADC resolution mode uses only a 14-bit segment of the ADC range.

2.6 Analog Output AOUT

The analog output is used for outputting the analog signal conditioning result and for "end of line" communication via the ZACwire™ interface one-wire communication interface (OWI). The ZSC31150 supports four different modes of the analog output in combination with the OWI behavior:

- OWIENA: Analog output is deactivated; OWI communication is enabled.
- OWIDIS: Analog output is active (~2ms after power-on); OWI communication is disabled.
- OWIWIN: Analog output will be activated after the time window; OWI communication is enabled in a time window of ~500ms (maximum); transmission of the "START_CM" command must be finished during the time window.
- \bullet OWIANA: Analog output will be activated after a \sim 2ms power on time; OWI communication is enabled in a time window of ~500ms (maximum); transmission of the START_CM" command must be finished during time window; to communicate, the internal driven potential at AOUT must be overwritten by the external communication master (AOUT drive capability is current limited).

The analog output potential is driven by a unity gain output buffer for which the input signal is generated by a 12.4-bit resistor-string DAC. The output buffer (BAMP), which is a rail-to-rail op amp, is offset compensated and current limited. Therefore, a short-circuit of the analog output to ground or the power supply does not damage the ZSC31150.

2.7 Serial Digital Interface

The ZSC31150 includes a serial digital interface (SIF), which is used for communication with the circuit to calibrate the sensor module. The serial interface is able to communicate with two communication protocols: I²C and the ZACwire™ one-wire communication interface (OWI). The OWI can be used to for an "end of line" calibration via the analog output AOUT of the complete assembled sensor module.

Refer to the *ZSC31150 Functional Description* for a detailed description of the serial interfaces and communication protocols.

2.8 Failsafe Features, Watchdog and Error Detection

The ZSC31150 detects various possible errors. A detected error is indicated by a change in the internal status in Diagnostic Mode (DM). In this case, the analog output is set to LOW (minimum possible output value; i.e., the lower diagnostic range LDR) and the output registers of the digital serial interface are set to a significant error code.

A watchdog oversees the continuous operation of the CMC and the running measurement loop. The operation of the internal clock oscillator is verified continuously by the oscillator failure detection.

A check of the sensor bridge for broken wires is done continuously by two comparators watching the input voltage of each input (sensor connection and short check). Additionally, the common mode voltages of the sensor and sensor input short are watched continuously (sensor aging).

Different functions and blocks in the digital section, e.g. the RAM, ROM, EEPROM, and register content, are watched continuously. Refer to the *ZSC31150 Functional Description* for a detailed description of safety features and methods of error indication.

2.9 High Voltage, Reverse Polarity, and Short Circuit Protection

The ZSC31150 is designed for 5V power supply operation.

The ZSC31150 and the connected sensor are protected from overvoltage and reverse polarity damage by an internal supply voltage limiter. The analog output AOUT can be connected with all potentials (short circuit, over-voltage, and reverse voltage) in the protection range under all potential conditions at the VDDE and VSSE pins.

All external components (see section [3\)](#page-17-0) are required to guarantee this operation. The protection is not time limited. Refer the *ZSC31150 Technical Note – High Voltage Protection* for a detailed description of protection cases and conditions.

3. Application Circuit Examples

The application circuits contain external components that are needed for over-voltage, reverse polarity, and short circuit protection.

Recommendation: Check the ZSC31150 product page [www.IDT.com/ZSC31150](http://www.idt.com/zsc31150) for other application examples given in application notes. Note: Some application notes require a customer login—see section [9](#page-22-1) for details.

Symbol	Parameter	Min	Typ	Max	Unit	Notes
C ₁	С	100		470	nF	
C ₂	C	100			nF	
$C3$ [a]	С	4	47	160	nF	The value of C3 is the sum of the load capacitor and the cable capacitance.
C4, C5 [a]	C			10	nF	Recommended to increase EMC immunity.
R ₁			10		$k\Omega$	
R_{IBR}	R	Refer to section 1.2.			Ω	

Table 3.1 Application Circuit Parameters

[a] Higher values for C3, C4, and C5 increase EMC immunity.

Figure 3.2 Bridge in Voltage Mode, External Thermistor

4. Pin Configuration, Latch-Up and ESD Protection

4.1 Pin Configuration and Latch-up Conditions

Table 4.1 Pin Configuration and Latch-Up Conditions

[a] **Usage**: If "Required" is specified, an electrical connection is necessary; refer to the application circuits in section [3.](#page-17-0) **Connection:** To be connected to this potential if not used or if no application/configuration-related constraints are given.

4.2 ESD Protection

All pins have an ESD protection of > 2000V. Additionally, the pins VDDE, VSSE and AOUT have an ESD protection of >4000V.

ESD protection referenced to the Human Body Model is tested with devices during product qualification. The ESD test follows the Human Body Model with 1.5kΩ/100pF based on MIL 883, Method 3015.7.

5. Package

5.1 SSOP14 Package

The standard packages of the ZSC31150 are the SSOP14 green package (5.3mm body width) with a lead pitch of 0.65mm and the DFN14 (4mmx5mm) package with a lead pitch of 0.5mm.

For the SSOP14 package markings shown in [Figure 5.1,](#page-20-3) YYWW refers to the last two digits of the year (YY) and two digits for the work-week designation (WW). XXXXXXXX refers to the lot number.

Figure 5.1 SSOP14 Pin Diagram

5.2 14-DFNPackage

For the 14-DFN package, the pin assignment is the same as in SSOP14. Refer to the *ZSC31150 Technical Note – Die and Package Specifications* for a description of package markings.

[Figure 5.2](#page-21-2) provides the dimensions for the 14-DFN package option, which are based on JEDEC MO-229. The 14-DFN package has wettable flanks.

Figure 5.2 Outline Drawing for 14-DFN Package with Wettable Flanks

Table 5.1 14-DFN Package Dimensions

6. Quality and Reliability

The ZSC31150 is qualified according to the AEC-Q100 standard, operating temperature grade 0. A fit rate < 5fit (temperature =55°C, S=60%) is guaranteed. A typical fit rate of the C7D technology, which is used for ZSC31150, is 2.5fit.

7. Customization

For high-volume applications, which require an upgraded or downgraded functionality compared to the standard ZSC31150, IDT can customize the circuit design by adding or removing certain functional blocks.

For this purpose, IDT has a considerable library of sensor-dedicated circuitry blocks. As a result, IDT can provide a custom solution quickly. Please contact IDT for further information.

9. Related Documents and Tools

Visit the ZSC31150 product page [www.IDT.com/ZSC31150](http://www.idt.com/zsc31150) on the IDT website at [www.IDT.com](http://www.idt.com/) or contact your nearest sales office for the latest version of this document and related documents.

10. Glossary

11. Document Revision History

